



DFLZ5V1 - DFLZ39

1.0W SURFACE MOUNT POWER ZENER DIODE PowerDI123

Features

- 1W Power Dissipation on FR-4 PCB
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI[®]123
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.01 grams (Approximate)



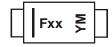
Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
(Type Number)-7*	PowerDI123	3,000/Tape & Reel

- * Add "-7" to the appropriate type number in Electrical Characteristics Table. Example: 6.2V Zener = DFLZ6V2-7
 - 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 - 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine 1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Fxx = Product Type Marking Code (See Electrical Characteristics Table) YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	2007	2008	200	9 20)10	2011		2016	2017	2018	2019	2020	2021
Code	U	V	W		X	Υ		D	Е	F	G	Н	I
Mon	th	Jan	Feb	Mar	Apr	Ma	y Jui	n Jul	Aug	Sep	Oct	Nov	Dec
Cod	е	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Cha	racteristic	Symbol	Value	Unit
Forward Voltage	@ I _F = 200mA	V _F	1.2	V

Thermal Characteristics

Characteristic	Symbol	Тур	Value	Unit
Power Dissipation (Note 5)	P_{D}	_	1.0	W
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	110	_	°C/W
Thermal Resistance Junction to Soldering Point (Note 6)	$R_{ heta JS}$	_	9	°C/W
Operating and Storage Temperature Range	T_J,T_STG	_	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

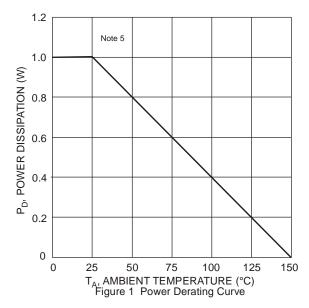
	Marking Codes	Zener Voltage Range (Note 7)			Zener Impedance		Maximum Reverse Current (Note 7)		Temperature Coefficient @ IzTC		
Number	Codes		Vz @ Izt		I _{ZT}	$\mathbf{Z}_{ZT} @ \mathbf{I}_{ZT} \qquad \qquad \mathbf{I}_{R} \qquad \qquad @ \mathbf{V}_{R}$		%/ <u>°</u> C			
		Nom (V)	Min (V)	Max (V)	mA	Typ (Ω)	Max (Ω)	μΑ	٧	Min	Max
DFLZ5V1	FHK	5.1	4.8	5.4	100	2	6	2.5	1	-0.08	-0.2
DFLZ5V6	FHL	5.6	5.2	6.0	100	1	4	10	2	-0.04	0.04
DFLZ6V2	FHN	6.2	5.8	6.6	100	1	3	5	2	-0.01	0.06
DFLZ6V8	FHO	6.8	6.4	7.2	100	1	3	5	3	0	0.07
DFLZ7V5	FHQ	7.5	7.0	7.9	100	1	2	5	3	0	0.07
DFLZ8V2	FHR	8.2	7.7	8.7	100	1	2	5	3	0.03	0.08
DFLZ9V1	FHT	9.1	8.5	9.6	50	1	4	5	5	0.03	0.08
DFLZ10	FHU	10	9.4	10.6	50	1	4	5	7.5	0.05	0.09
DFLZ11	FHV	11	10.4	11.6	50	1	7	4	8.2	0.05	0.10
DFLZ12	FHW	12	11.4	12.7	50	1	7	3	9.1	0.05	0.10
DFLZ13	FHX	13	12.4	14.1	50	1	10	2	10	0.05	0.10
DFLZ15	FHZ	15	13.8	15.6	50	1	10	1	11	0.05	0.10
DFLZ16	FJA	16	15.3	17.1	25	1	15	1	12	0.06	0.11
DFLZ18	FJF	18	16.8	19.1	25	2	15	1	13	0.06	0.11
DFLZ20	FJG	20	18.8	21.2	25	3	15	1	15	0.06	0.11
DFLZ22	FJK	22	20.8	23.3	25	3	15	1	16	0.06	0.11
DFLZ24	FJL	24	22.8	25.6	25	2	15	1	18	0.06	0.11
DFLZ27	FJN	27	25.1	28.9	25	3	15	1	20	0.06	0.11
DFLZ30	FJQ	30	28	32	25	8	15	1	22	0.06	0.11
DFLZ33	FJR	33	31	35	25	5	15	1	24	0.06	0.11
DFLZ36	FJS	36	34	38	10	5	40	1	27	0.06	0.11
DFLZ39	FJT	39	37	41	10	5	40	1	30	0.06	0.11

Notes:

^{5.} Device mounted on 1.5" x 1.5", FR-4 PCB; 2 oz. Cu with 1"x1" pad layout.
6. Theoretical RθJS calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

^{7.} Short duration pulse test used to minimize self-heating effect.





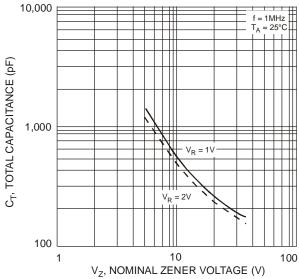
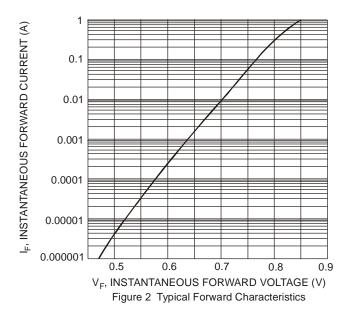


Figure 3 Typical Total Capacitance vs. Nominal Zener Voltage

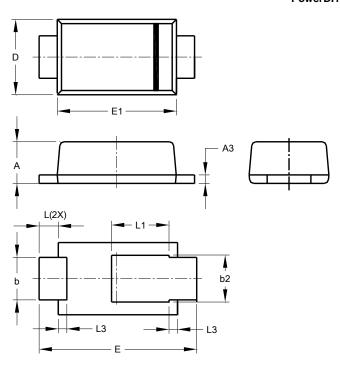




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123

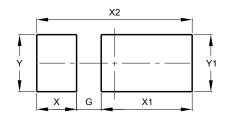


PowerDI123						
Dim	Min	Max	Тур			
Α	0.93	1.00	0.98			
A3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



Dimensions	Value (in mm)
G	0.65
X	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50



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